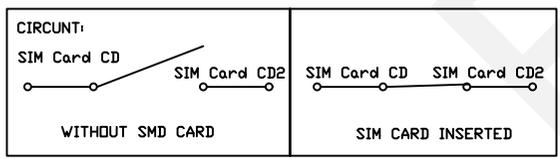
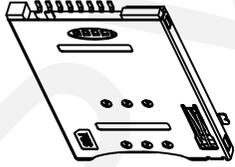
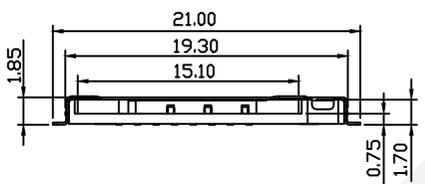


PCB PAD
 RECOMMENDED PCB LAYOUT
 GENERAL TOLERANCE:±0.05



SIM Pin Assignment	
Pin#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

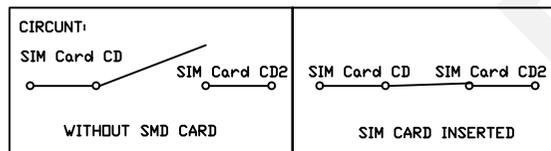
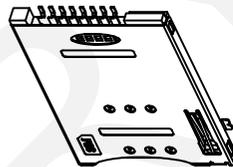
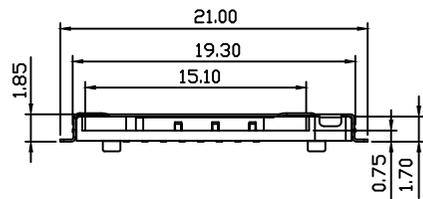
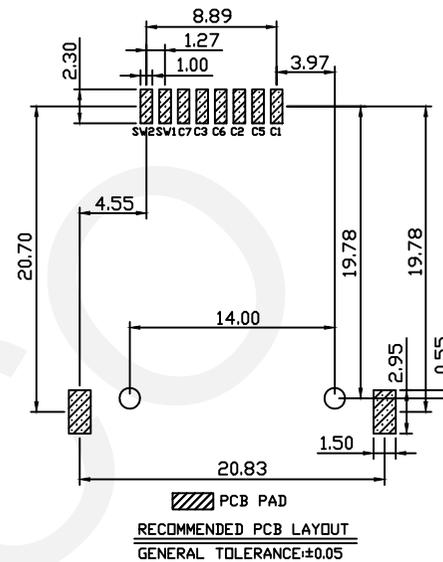
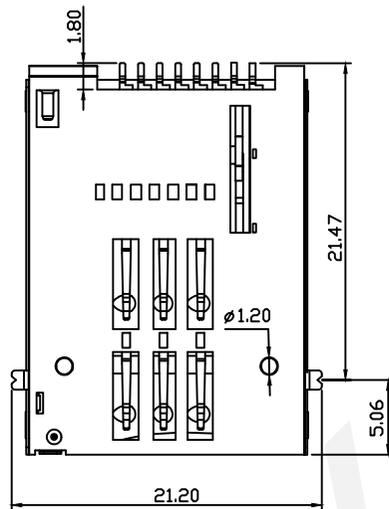
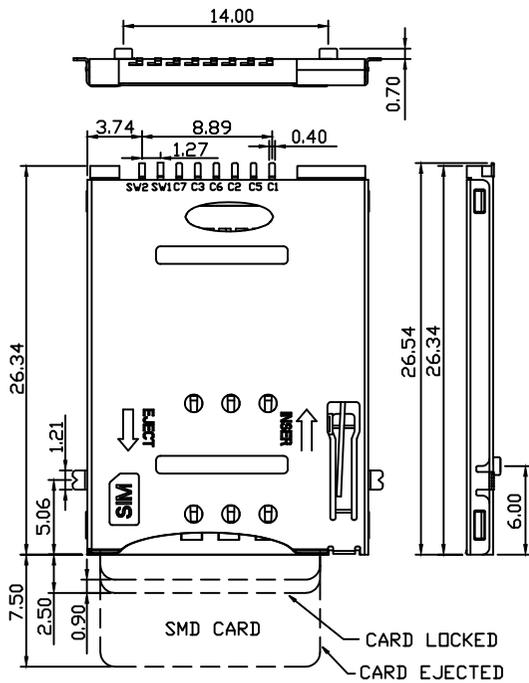
Material:
 Insulator:High-Temperature Plastic,UL94V-0.Black.
 Contact:Copper Alloy,T=0.15mm;
 Shell:Stainless Steel, T=0.15mm
 Finish:
 Terminal:50u' Min Nickel Underplated On Allover,
 Gold Plating On Contact Area,80u' Min Tin on Solder Tail.
 Shell:50u' Nickel Underplated On Allover,Gold Flash On Solder Latch.

Electrical:
 Current Rating:0.5A;Voltage Rating:5.0 Vrms.
 Insulation Resistance:500M Min.At DC 500V DC
 Withstanding Voltage:250V ACrms For 1 Minute.
 Contact Resistance:100M Max.At 10MA/20mV MAX.
 Operating Temperature:-55°C TO +85°C;
 Mating Cycles:5000 Insertions

NINGBO ERYCO ELECTRONIC CO.,LTD

UNITS:mm	SHEET SIZE: A4			SCALE:---	DRWN BY PAN
0~3	3~18	18~50	50~120	CHK'D BY FENG	
±0.12	±0.15	±0.3	±0.5	APPR BY ZHAN	

SIM CARD CONN:PUSH PUSH,6P,
 H1.85mm,SMD With CD Pin,With Post
 THIRD ANGLE PROJECTION
 ERYAYIM-030-6P



SIM Pin Assignment	
Pin#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

Material:

Insulator:High-Temperature Plastic,UL94V-0.Black.

Contact:Copper Alloy,T=0.15mm;

Shell:Stainless Steel, T=0.15mm

Finish:

Terminal:50u' Min Nickel Underplated On Allover,
Gold Plating On Contact Arer,80u' Min Tin on Solder Tail.

Shell:50u' Nickel Underplated On Allover,Gold Flash On Solder Latch.

Electrical:

Current Rating:0.5A;Voltage Rating:5.0 Vrms.

Insulation Resistance:500M Min.At DC 500V DC

Withstanding Voltage:250V ACrms For 1 Minute.

Contact Resistance:100M Max.At 10MA/20mV MAX.

Operating Temperature:-55°C TO +85°C:

Mating Cycles:5000 Insertions

NINGBO ERYCO ELECTRONIC CO.,LTD

UNITS:mm	SHEET SIZE: A4			SCALE:---
0~3	3~18	18~50	50~120	
±0.12	±0.15	±0.3	±0.5	

DRWN BY PAN

CHK'D BY FENG

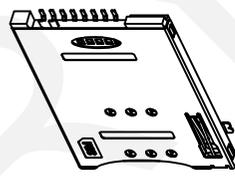
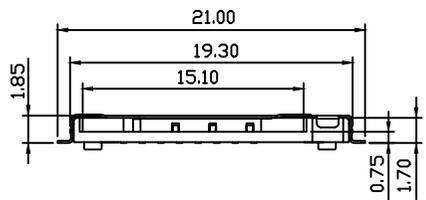
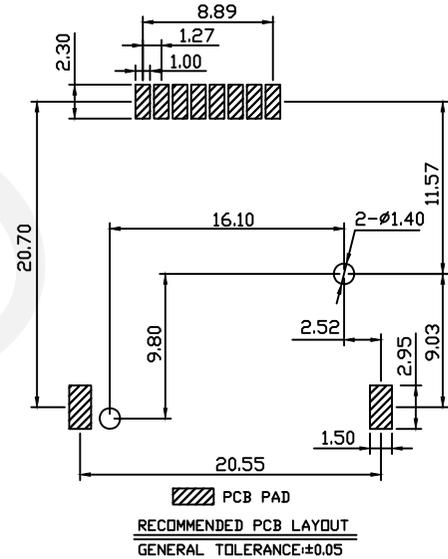
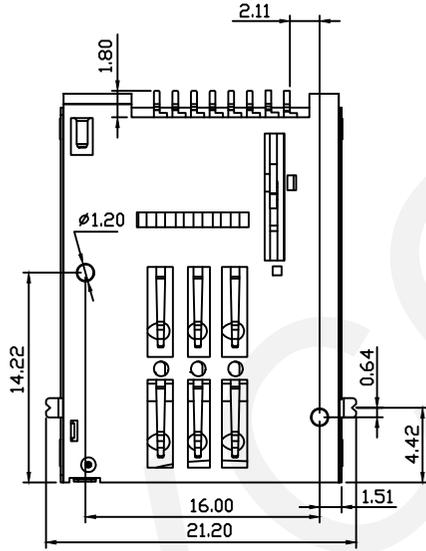
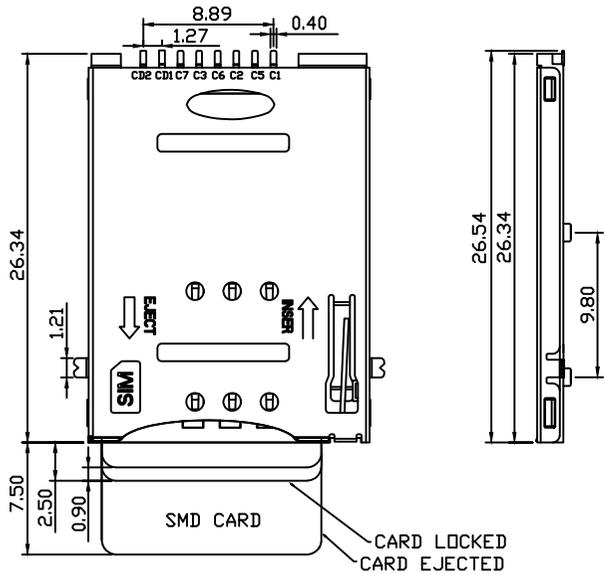
APPR BY ZHAN

SIM CARD CONN:PUSH PUSH,6P,
H1.85mm,SMD With CD Pin,With Post

THIRD ANGLE PROJECTION

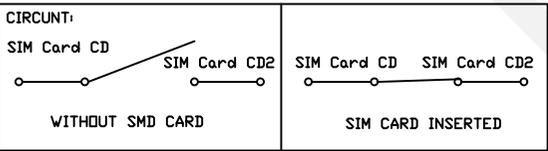


ERYAYIM-030-6P-1-R



Material:
 Insulator:High-Temperature Plastic,UL94V-0.Black.
 Contact:Copper Alloy,T=0.15mm;
 Shell:Stainless Steel, T=0.15mm
 Finish:
 Terminal:50u' Min Nickel Underplated On Allover,
 Gold Plating On Contact Area,80u' Min Tin on Solder Tail.
 Shell:50u' Nickel Underplated On Allover,Gold Flash On Solder Latch.

Electrical:
 Current Rating:0.5A;Voltage Rating:5.0 Vrms.
 Insulation Resistance:500M Min.At DC 500V DC
 Withstanding Voltage:250V ACrms For 1 Minute.
 Contact Resistance:100M Max.At 10MA/20mV MAX.
 Operating Temperature:-55°C TO +85°C:
 Mating Cycles:5000 Insertions

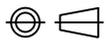


SIM Pin Assignment	
Pin#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

NINGBO ERYCO ELECTRONIC CO.,LTD

UNITS:mm	SHEET SIZE: A4			SCALE:---
0~3	3~18	18~50	50~120	
±0.12	±0.15	±0.3	±0.5	

DRWN BY PAN
 CHK'D BY FENG
 APPR BY ZHAN

SIM CARD CONN:PUSH PUSH,6P,
 H1.85mm,SMD With CD Pin,With Post
 THIRD ANGLE PROJECTION

 ERYAYIM-030-6P-3-R